



## RUCEBBLE

1U FANLESS 19", DC-DC REDUNDANT SERVER



- Intel® Coffee Lake-Refresh 8th/9th Processor (up to 65W)
- 2 x SO-DIMM DDR4 2400/2666 MHz up to 64GB
- 1 x PClex16 Slot
- 1 x M.2 M 2280, 1 x M.2 E 2230,
  1 x mPCle Full Size, 1 x PCle X16 Expansion Slot
- 6 x USB, 3 x DisplayPort, 2 x LAN, 1 x Line-out/
- 2 x 2.5" SATA HDD/ SSD Easy Swap Tray

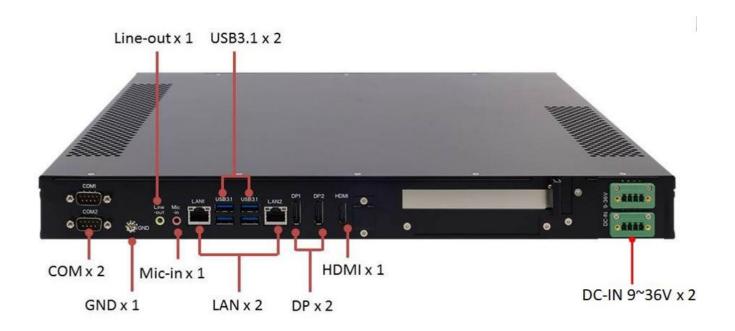
## **Specifications**

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Processor	Socket LGA 1151 for Intel® Core i7/i5/i3/Celeron® (Supports up to 65W) Intel 8th/9th Processor	
Chipset	Intel® Q370 Chipset	
Memory type	2 x DDR4 SO DIMM up to 64 GB	
Expansion Slot	2x SATAIII, $2.5''$ SSD, $1x$ M.2 (Key M, $2242/2280$ ) with PCIe and SATA Signal, $1x$ PCIe $x16$	
DISPLAY		
Display Port	Resolution up to 4096 x 2304 60@Hz	
STORAGE		
HDD/SDD	2 x 2.5" SATA HDD/SSD easy swap tray	
ETHERNET		
Ethernet	Intel® I210 & I219LMGbE LAN (support 10/100/1000 Mbps for x2 RJ45 ports)	
REAR I/O		
Display Port	2 x DP, 1x HDMI	
Ethernet	2 x RJ45 Intel® I210 & I219LM GbE LAN (support 10/100/1000 Mbps)	
Audio	2 x 3.5mm Audio Jacks (1 x MIC, 1 x Line-Out)	
COM	2 x RS232/422/485 (select by BIOS)	
USB Port	4 x USB 3.1(10Gb/s)	
DC-IN	2 X 4P Terminal Block	
FRONT I/O		
Button	1 x Power Button w/Indicator LED	
Indicator LED	HDD	
USB Port	2 x USB 2.0	
Easy Swap SSD Tray	x 2	
Power Requir	EMENT	
Power Input	9~36V DC IN	
APPLICATIONS,	OPERATING SYSTEM	
Applications	Commercial and Industrial Platforms, Embedded Computing, Process Control, Intelligent Automation and manufacturing application	

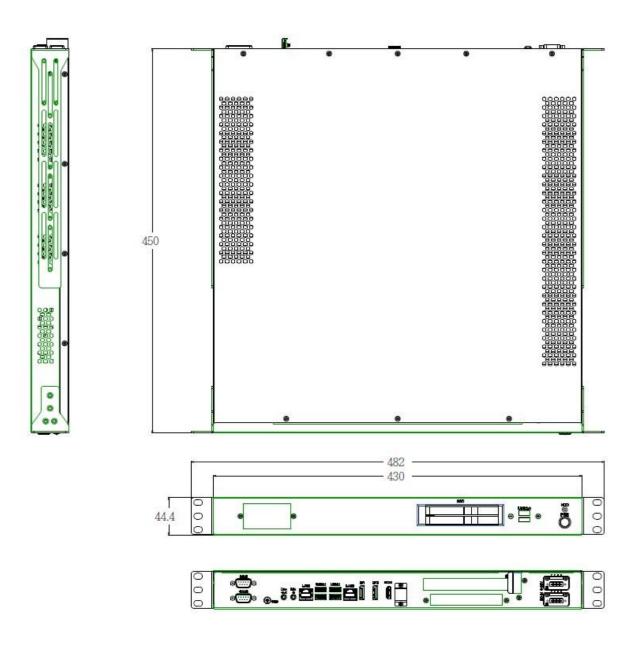
Operating System	Windows 10 64Bit			
Operating system				
	Ubuntu13.04, Ubuntu13.10			
	Ubuntu 14.04, Fedora 20			
PHYSICAL				
Dimensions	440 x 430 x 44 mm			
(W x D x H)				
Weight	8.92 kg			
Chassis	SECC			
Heatsink	Aluminum Alloy, Corrosion Resistant			
Finish	Anodic aluminum oxide			
ENVIRONMENTA	<b>L</b>			
MIL-STD-810GTest	Method 507.5, Procedure II (Temperature & Humidity)			
	Method 501.5, Procedure I (Storage/High Temperature)			
	Method 501.5, Procedure II (Operation/High Temperature)			
	Method 502.5, Procedure I (Storage/Low Temperature)			
	Method 502.5, Procedure II (Operation/Low Temperature)			
	Method 503.5, Procedure I (Temperature shock)			
Green Product	RoHS compliance			
Operating	w/o Graphic Card (ET: -20 to 60°C; UT: -30 to 70°C); w/Graphic Card			
Temperature	(0°C to 50°C)			
Storage	-30°C to 85°C			
Temperature				
Relative Humidity	5% to 95%, non-condensing			
EMC	CE and FCC compliance			

## **APPEARANCE**





## **Dimensions**



This datasheet is for marketing purposes only and does not constitute a warranty. All specifications, dimensions, and data are subject to change without notice. For the latest specifications and updates, please contact your 7STARLAKE representatives.